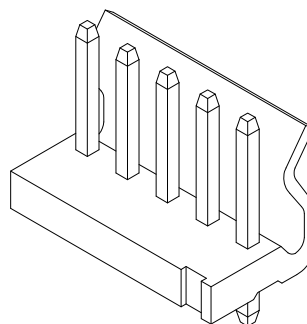
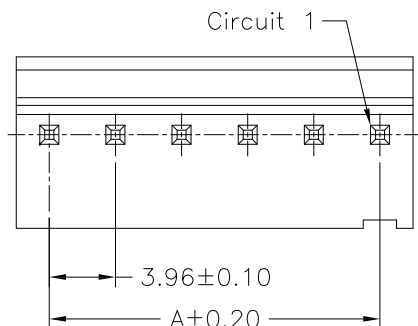
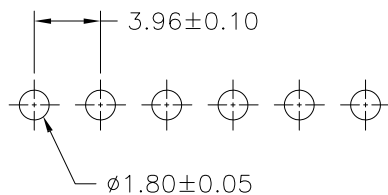
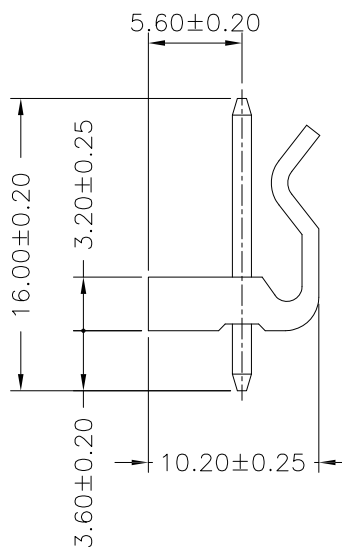
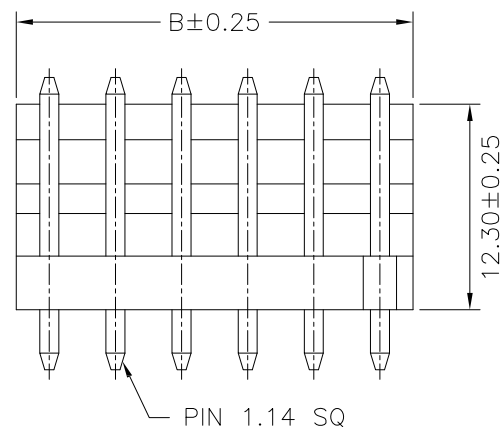




3D VIEW



RECOMMENDED PCB LAYOUT

NOTES:

1. Material:

Housing: Nylon 66, UL 94V-2 Rated.
Color: Translucent(Natural).
Contact: Brass.
Plating: Tin Plating over Nickel.

2. Electrical Specification:

Operation Voltage: 250V AC/DC.
Current Rating: 7 Ampere AC/DC per Contact.
Contact Resistance: 10mΩ Max.
Insulation Resistance: 1000MΩ Min.
Dielectric Withstanding Voltage: 1500V AC per Minute.

3. Environmental:

Operating Temperature: -25°C to +85°C.

Poles	Dimensions (mm)		Poles	Dimensions (mm)	
	A	B		A	B
2	3.96	7.92	12	43.56	47.52
3	7.92	11.88	13	47.52	51.48
4	11.88	15.84	14	51.48	55.44
5	15.84	19.80	15	55.44	59.40
6	19.80	23.76	16	59.40	63.36
7	23.76	27.72	17	63.36	67.32
8	27.72	31.68	18	67.32	71.28
9	31.68	35.64	19	71.28	75.24
10	35.64	39.60	20	75.24	79.20
11	39.60	43.56			

Part Number:

CW39-MXXVDT1-02

Wafer 3.96mm Series
M: Male Type
XX: 02~20Pins
V: Vertical Type

Product Number:
02: H=12.4mm, DIP=3.6mm
1: Natural Color(Translucent)
T: Tin Plating
D: DIP Type

A	04/10/19	RELEASED FOR PRODUCTION			
REV	DATE	DESCRIPTION			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MM TOLERANCES ARE: DECIMALS ANGLES .X ± .38 ± 3° .XX ± .25 .XXX ± .20		CAD GENERATED DRAWING, DO NOT MANUALLY UPDATE		 凱聯科技股份有限公司 Conn-Link Technology Inc.	
		APPROVALS	DATE		
		DRAWN Chris	04/10/19		
		CHECKED Cindy	04/10/19		
		APPV Jason	04/10/19		
DO NOT SCALE DRAWING		SHEET 1 OF 1	SCALE NONE	DWG. NO. CW39-MXX-002	REV. A



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DESCRIPTION 3.96mm Wire to Board Connector, Wafer
Vertical Type, DIP 3.6mm, 02~20Pins, Translucent